

# Elevate Your Research, Navigate Your Future.

Submit your abstract for TechConnect World, June 17-19, 2024

All interested persons must submit applications to Karla Schramm at [kschramm@usf.edu](mailto:kschramm@usf.edu)

TechConnect's commercialization pipeline picks up your innovation at any stage and supports its growth. Whether you have a novel idea and research or you've already gained market traction, we represent the largest innovation pipeline in the world, and we're prepared to put it to work for your benefit.

At TechConnect World Innovation Conference, submit your abstract for a chance to share an oral presentation at one of 35+ symposia or present a poster in the larger-than-life Expo to your peers in these key areas:

- advanced materials & manufacturing,
- energy & sustainability,
- biotech & medical,
- electronics & microsystems,
- space and defense,
- and AI innovations.

## Submit Your Abstract for Presentation:

All submissions will be reviewed by our prestigious international review committee with a preference towards applications-focused work with clear industry relevance. Symposia are specifically designed to have both industry and academic speakers.

Your submission should include a 500-word maximum text-only abstract. You may also upload a 2-page maximum PDF file with additional information, figures, and references to relevant literature, including publications and patents by the author's group. This will enable the reviewers to make a more accurate assessment of your submission and help the symposium chairs to place your work in the most appropriate part of the program.

New for 2024! TechConnect World will be awarding a Poster Abstract Prizes for our 2024 meeting. Abstracts MUST be submitted on time (no late submissions will be considered) and only submissions from undergraduate or graduate students will be considered. Awards will be submitted based on technical strength and writing quality of abstracts. Awardees will be notified at time of notification of abstract

acceptance/rejection. All awardees will be awarded free registration to the 2024 meeting. Submit the below information to your Technology Transfer office representative, Karla Schramm at [kschramm@usf.edu](mailto:kschramm@usf.edu) for consideration of your poster abstract for our TechConnect World Poster Abstract Prize.

**To Submit a Poster Only Abstract:**

1. Pick an Industry Sector
  - Advanced Materials
  - Advanced Manufacturing
  - Energy Innovation
  - Sustainability Innovation
  - Biotech & Medical
  - Electronics & Microsystems
  - AI Innovation
  - Single Topic Symposia
  
2. Select a Symposium, and a Topic/Application Area covered by that symposium, using the [pulldown menu](#)
3. Complete the Poster Abstract Submission form including the 500 word text-only summary
4. Alternatively select a [Symposium: Topic/Application Area](#), then follow steps 3 – 4.
5. Submit all information to Karla Schramm at [kschramm@usf.edu](mailto:kschramm@usf.edu)

If you have any additional questions, please reach out to your University of South Florida Technology Transfer representative, Karla Schramm at [kschramm@usf.edu](mailto:kschramm@usf.edu)